

# SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

# LC74761 LC74761M

# CMOSIC On-Screen Display LSI

#### **Overview**

The LC74761 and LC74761M are on-screen display CMOS LSIs that superimpose text and low-level graphics onto a TV screen (video signal) under microcontroller. The display characters have a 12 by 18 dots structure, and 256 characters are provided.

#### **Features**

- Display structure: 12 lines by 24 characters (up to 288 characters)
- Maximum character display: Up to 288 characters
- Character configuration: 12 (W) by 18 (H) dots structure
- Number of characters: 256 characters (254 plus space 1 font and transparent space 1 font)
- Character sizes: Three sizes (normal, double, and triple sizes)
- Display starting positions: 64 horizontal and 64 vertical locations
- Reverse video function: Characters can be inverted on a per character basis.
- Flashing types: Two types with periods of 0.5 and 1.0 second on a per character basis (duty fixed at 50%)
- Background color: One of eight colors (when internal synchronization used)
- External control input: Serial data input in 8-bit units
- · Built-in horizontal/vertical sync separation circuit, AFC circuit, and synchronization detector
- Video output: Composite video signal output in NTSC, PAL, PAL-M, PAL-N, PAL60, NTSC4.43, or SECAM format

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# **Specifications**

# Absolute Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>DD</sub> max	V <sub>DD1</sub> , V <sub>DD2</sub> pins	$V_{SS} - 0.3 \text{ to } V_{SS} + 7.0$	V
Maximum input voltage	V <sub>IN</sub> max	All input pins	$V_{SS} - 0.3 \text{ to } V_{DD} + 0.3$	V
Maximum output voltage	V <sub>OUT</sub> max	HSYNC <sub>OUT</sub> , VSYNC <sub>OUT</sub> , SYNC <sub>DET</sub> pins	$V_{SS} - 0.3 \text{ to } V_{DD} + 0.3$	V
Allowable power dissipation	Pd max		300	mW
Operating temperature	Topr		-30 to +70	°C
Storage temperature	Tstg		-40 to +125	°C

# Allowable Operating Ranges at $Ta = -30 \text{ to } +70^{\circ}\text{C}$

Devemeter	Cumphal	Conditions		Ratings				
Parameter	Symbol	Conditions		min	typ	max	Unit	
Supply voltage	$V_{DD1}$	V <sub>DD1</sub> pin		4.5	5.0	5.5	V	
Supply voltage	$V_{DD2}$	V <sub>DD2</sub> pin		4.5	5.0	1.27 V <sub>DD1</sub>	V	
	V <sub>IH1</sub>	RST, CS, SIN, SCLK pins		0.8 V <sub>DD1</sub>		V <sub>DD1</sub> + 0.3	V	
Input high level voltage	V <sub>IH2</sub>	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins				V <sub>DD1</sub> + 0.3	V	
	V <sub>IL1</sub>	RST, CS, SIN, SCLK pins	V <sub>SS</sub> - 0.3		0.2 V <sub>DD1</sub>	V		
Input low level voltage	V <sub>IL2</sub>	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins	V <sub>SS</sub> - 0.3		0.3 V <sub>DD1</sub>	V		
Input voltage	V <sub>IN</sub>	FC, AMP <sub>IN</sub> pins		V <sub>SS</sub> - 0.3		V <sub>DD1</sub> + 0.3	V	
	V <sub>IN1</sub>	CVIN pins			2 V <sub>PP</sub>		V	
Composite video signal input voltage	V <sub>IN2</sub>	CV <sub>CR</sub> pins			2 V <sub>PP</sub>		V	
	V <sub>IN3</sub>	SYNC <sub>IN</sub> pins			2 V <sub>PP</sub>	2.5 V <sub>PP</sub>	V	
			NTSC		14.318		MHz	
Oscillator frequency	F <sub>OSC1</sub>	Xtal <sub>IN1</sub> , Xtal <sub>OUT1</sub> , Xtal <sub>IN2</sub> ,	PAL		17.734		MHz	
	FOSC1	Xtal <sub>OUT2</sub> pins; 4fsc	PAL-M		14.302		MHz	
			PAL-N		14.328		MHz	

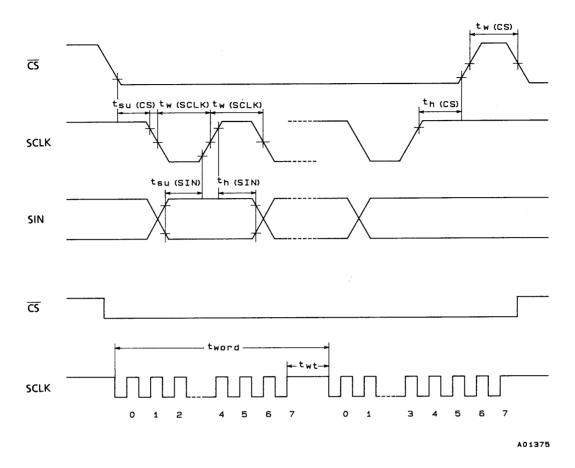
# Electrical Characteristics at Ta = -30 to +70°C, with $V_{DD1} = V_{DD2} = 5$ V unless otherwise specified

Davameter	Cumbal	Conditions		- Unit			
Parameter	Symbol	Conditions	min	typ	max	Offic	
Output off leakage current	I <sub>leak1</sub>	CV <sub>OUT</sub> pin			10	μA	
Input off leakage current	I <sub>leak2</sub>	CV <sub>IN</sub> , CV <sub>CR</sub> pins			10	μA	
Output high level voltage	V <sub>OH</sub>	$\label{eq:hsyncout} \begin{array}{l} \mbox{HSYNC}_{OUT}, \mbox{ VSYNC}_{OUT}, \\ \mbox{ \underline{SYNC}}_{DET}, \mbox{ SECAM}, \mbox{ \underline{525}}/625, \\ \mbox{ \overline{NTSC}}/\mbox{PAL}, \mbox{ \underline{3.58}}/4.43, \mbox{ AMP}_{OUT}, \\ \mbox{PD}_{OUT} \mbox{ pins; V}_{DD1} = 4.5 \mbox{ V, I}_{OH} = -1.0 \mbox{ mA} \end{array}$	3.5			V	
Output low level voltage	V <sub>OL</sub>	$\begin{array}{l} \label{eq:hsyncout} \text{HSYNC}_{\text{OUT}}, \text{ VSYNC}_{\text{OUT}}, \\ \frac{\text{SYNC}_{\text{DET}}, \text{ SECAM}, \overline{525}/625,}{\text{NTSC}/\text{PAL}, \overline{3.58}/4.43, \text{ AMP}_{\text{OUT}},} \\ \text{PD}_{\text{OUT}} \text{ pins; V}_{\text{DD1}} = 4.5 \text{ V, I}_{\text{OL}} = 1.0 \text{ mA} \end{array}$			1.0	V	
Input current	I <sub>IH</sub>	$\overline{\text{RST}}$ , $\overline{\text{CS}}$ , SIN, SCLK, SECAM, $\overline{525}/625$ , $\overline{\text{NTSC}}/\text{PAL}$ , $\overline{3.58}/4.43$ pins; $V_{\text{IN}} = V_{\text{DD1}}$			1	μА	
Input current	I <sub>IL</sub>	SECAM, $\overline{525}/625$ , $\overline{NTSC}/PAL$ , $\overline{3.58}/4.43$ pin; $V_{IN} = V_{SS1}$	-1			μА	
Oscillator frequency	F <sub>OSC3</sub>	$VCO_{IN}$ , $VCO_{OUT}$ pins; $FC = 1/2 V_{DD1}$		14.12		MHz	
Operating current dissipation	I <sub>DD1</sub>	V <sub>DD1</sub> pin; All outputs open, Xtal: 4fsc			15	mA	
Operating current dissipation	I <sub>DD2</sub>	$V_{DD2}$ pin; $V_{DD2} = 5.0 \text{ V}$			20	mA	

# Timing Characteristics at Ta = -30 to $+70^{\circ}$ C, $V_{DD}$ = $5 \pm 0.5$ V

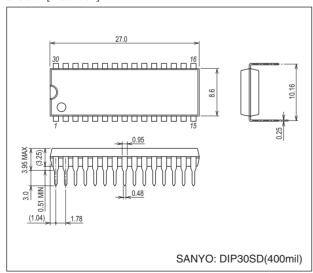
Dawa wa atau	0	Conditions		1.1-24			
Parameter	Symbol Conditions		min	typ	max	Unit	
Minimum input pulse width	t <sub>W(SCLK)</sub>	SCLK pin	200			ns	
William input puise width	t <sub>W(CS)</sub>	CS pin (during periods when CS is high)	1			μs	
Data setup time	t <sub>SU(CS)</sub>	CS pin	200			ns	
Data setup time	t <sub>SU(SIN)</sub>	SIN pin	200			ns	
Data hold time	t <sub>h(CS)</sub>	CS pin	2			μs	
Bata fiold time	t <sub>h(SIN)</sub>	SIN pin	200			ns	
One word write time	t <sub>word</sub>	Write time for 8 bits of data	4.2			μs	
one word while time	t <sub>wt</sub>	RAM data write time	1			μs	

# **Serial Data Input Timing**



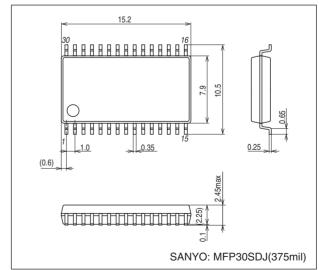
# **Package Dimensions**

unit : mm (typ) 3196A [LC74761]

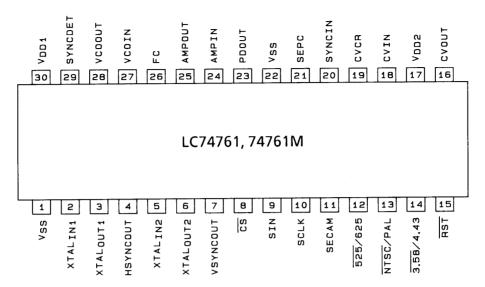


# **Package Dimensions**

unit: mm (typ)
3312 [LC74761M]



# **Pin Assignment**

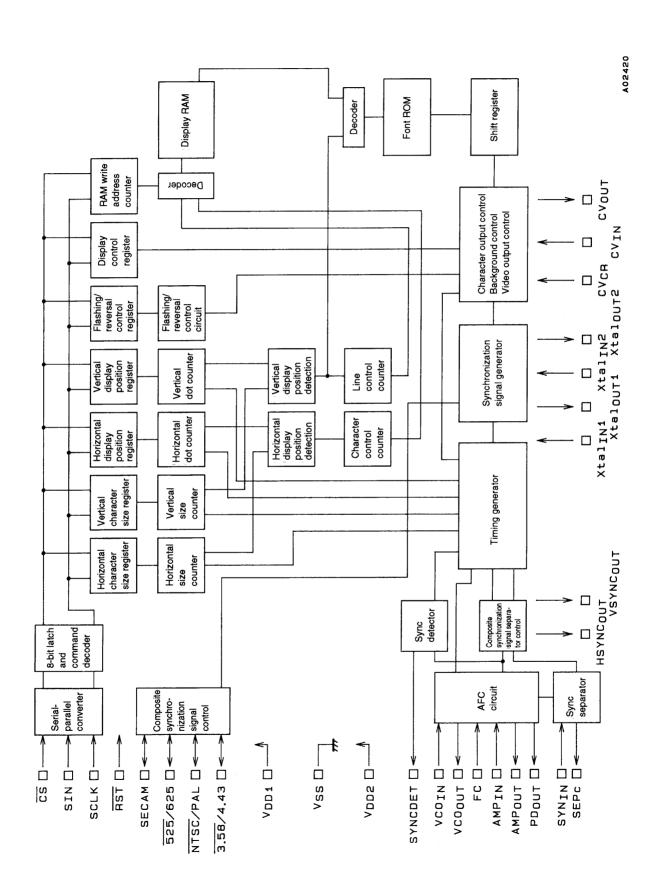


Top view

# **Pin Functions**

Pin No.	Symbol	Function	Description
1	V <sub>SS</sub>	Ground	Ground connection
2	Xtal <sub>IN1</sub>	0 11 77 77	Connection for the crystal and capacitor used to form the crystal oscillator that generates
3	Xtal <sub>OUT1</sub>	Crystal oscillator connection	the internal synchronization signal. The oscillator can be selected with a command switch.
4	HSYNC <sub>OUT</sub>	Horizontal synchronization output	Outputs the horizontal synchronization signal (AFC). The output polarity can be selected (metal option). Also functions as general output port (command switch).
5	Xtal <sub>IN2</sub>	Crystal oscillator connection	Connection for the crystal and capacitor used to form the crystal oscillator that generates
6	Xtal <sub>OUT2</sub>	Oryonal ocomiano cominocatori	the internal synchronization signal.
7	VSYNC <sub>OUT</sub>	Vertical synchronization output	Outputs the vertical synchronization signal. The output polarity can be selected (metal option). Also functions as general output port (command switch).
8	<del>CS</del>	Enable input	Enables/disables serial data input. Serial data is enabled when this pin is low (hysteresis input). Pull-up resistor built in (metal option).
9	SIN	Data input	Serial data input (hysteresis input). Pull-up resistor built in (metal option).
10	SCLK	Clock input	Clock input for serial data input (hysteresis input). Pull-up resistor built in (metal option).
11	SECAM	SECAM mode switch input/ output (command switch)	During input, switches between SECAM and other modes.  During output, functions as general output port or internal V output (command switch).  Low = other modes, high = SECAM mode
12	525/625	525/625 switch input/output (command switch)	During input, switches between 525 scan lines and 625 scan lines.  During output, functions as general output port or character data output (command switch).  Low = 525 lines, high = 625 lines
13	NTSC/PAL	NTSC/PAL switch input/output (command switch)	Switches the color mode between NTSC and PAL.  During output, functions as general output port or frame data output (command switch).  Low = NTSC, high = PAL
14	3.58/4.43	3.58/4.43 switch input/output (command switch)	Switch FSC between 3.58 MHz and 4.43 MHz.  During output, functions as general output port or half-tone output (command switch).  Low = 3.58, high = 4.43
15	RST	Reset input	System reset input pin, low is active (hysteresis input). Pull-up resistor built in (metal option).
16	CV <sub>OUT</sub>	Video signal output	Composite video output
17	$V_{DD2}$	Power supply connection	Power supply connection for composite video signal level generation
18	CV <sub>IN</sub>	Video signal input	Composite video input
19	CV <sub>CR</sub>	Video signal input	SECAM chroma signal input
20	SYNC <sub>IN</sub>	Sync separator circuit input	Built-in sync separator circuit video signal input
21	SEP <sub>C</sub>	Sync separator circuit	Built-in sync separator circuit
22	V <sub>SS</sub>	Ground	Ground connection
23	PD <sub>OUT</sub>	Control voltage output	AFC control voltage output
24	AMP <sub>IN</sub>	AFC filter connection	Filter connection
25	AMP <sub>OUT</sub>	A O III.GI COIIII.GCIIOII	Time connection
26	FC	Control voltage input	AFC control voltage input
27	VCO <sub>IN</sub>	LC oscillator connection	VCO LC oscillator circuit coil and capacitor connection
28	VCO <sub>OUT</sub>	LO OSCIIIATOI COTTIECTION	VOO LO OSCIIIATOI GIICUIT COII ATIU CAPACITOI COTTITECTION
29	SYNC <sub>DET</sub>	External synchronization signal detection output	Outputs the exclusive NOR of the horizontal synchronization signal (AFC) and CSYNC (sync separator). The output polarity can be selected (metal option). Also functions as general output port (command switch).
30	V <sub>DD1</sub>	Power supply connection	Power supply connection (+5 V: digital system power supply)

#### **System Block Diagram**



#### **Display Control Commands**

Display control commands are input in an 8-bit serial format. Commands consist of a command identification code in the first byte and data in the second and following bytes. The following commands are supported.

- 1 COMMANDO: Display memory (VRAM) write address setting command
- 2 COMMAND1: Display character data write command
- 3 COMMAND2: Vertical display start position and character size (lines 1 and 2) setting command
- 4 COMMAND3: Horizontal display start position and character size (lines 9 and 11) setting command
- 5 COMMAND4: Display control setting command 1
- 6 COMMAND5: Display control setting command 2
- 7 COMMAND6: Display control setting command 3
- 8 COMMAND7: Display control setting command 4

#### **Display Control Command Table**

				First	byte							Secon	nd byte			
Command	Comm	and ider	ntificatio	n code		Da	ata					Da	ata			
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
COMMAND0 Write address	1	0	0	0	V3	V2	V1	V0	0	0	0	H4	НЗ	H2	H1	H0
COMMAND1 Character write	1	0	0	1	0	0	at2	at1	c7	c6	c5	c4	сЗ	c2	c1	c0
COMMAND2 Vertical display start position	1	0	1	0	SZ 21	SZ 20	SZ 11	SZ 10	0	0	VP 5	VP 4	VP 3	VP 2	VP 1	VP 0
COMMAND3 Horizontal display start position	1	0	1	1	SZ B1	SZ B0	SZ 91	SZ 90	0	0	HP 5	HP 4	HP 3	HP 2	HP 1	HP 0
COMMAND4 Display control 1	1	1	0	0	RST	RAM	osc	RND	0	I/N	BLK 1	BLK 0	BK 1	ATS	0	DSP
COMMAND5 Display control 2	1	1	0	1	PH 2	PH 1	PH 0	I/E	0	TST	CHAL	BLK	RSL 1	RSL 0	CVM	XTS
COMMAND6 Display control 3	1	1	1	0	MOD 3	MOD 2	MOD 1	MOD 0	0	HFI	M30S	SMS	IOS	BCL 1	BCL 0	СВ
COMMAND70 Display control 4	1	1	1	1	0	0	0	LINS	0	vcos 1	LIN 5	LIN 4	LIN 3	LIN 2	LIN 1	LIN 0
COMMAND71 Display control 5	1	1	1	1	0	1	0	LINS	0	EG 2	PS 2	PS 1	VMN	SVIS	VNS	VSS
COMMAND72 Display control 6	1	1	1	1	1	0	0	LINS	0	0	0	0	MOD 3	MOD 2	MOD 1	MOD 0
COMMAND73 Display control 7	1	1	1	1	1	1	0	LINS	0	0	0	0	vcos 2	SOUT	VOUT	HOUT

Once the command identification code in the first bite is written, it is stored internally until the first byte of the following command is written. However, when the display character data write command (COMMAND1) is written, the system becomes locked in display character data write mode, and the first byte cannot be overwritten.

When the  $\overline{\text{CS}}$  pin is set high the command state is set to COMMANDO, i.e., display memory write address setting mode.

# 1 COMMAND0: Display Memory Write Address Setting Command

#### First data byte

DAG 4- DAZ	Danistan asses		Register content	Note								
DAU to DA7	DA0 to DA7 Register name		Function	Note								
7	_	1										
6	_	0	The command 0 identification code:									
5	_	0	sets the display memory write address.									
4	_	0										
3	V3	0										
3	VS	1										
2	V2	0										
2	٧Z	1	Display memory line address (from 0 to B (hexadecimal))									
-1	1/4	1/4	1/4	1/4	1/4	1/4	1/4	1/4	V1 0	0	Display memory line address (nom o to b (nexadecimal))	
'	V I	1										
0	VO	0										
U	VU	1										

# Second byte

DA04- DA7	DA0 to DA7 Register name		Register content	Note
DAU to DA7	Register name	State	Function	Note
7	_	0	Second byte identification code	
6	_	0		
5	_	0		
4	H4	0		
4	114	1		
3	H3	0		
3	113	1		
2	H2	0	Display memory character address (from 0 to 17 (hexadecimal))	
	112	1	Display memory character address (nom o to 17 (nexadecimal))	
1	H1	U1 0		
'	'''	1		
0	H0	0		
0	по	1		

Note: When the chip is reset by the  $\overline{\mathsf{RST}}$  pin, the register states (bits) are all cleared to 0.

# 2 COMMAND1: Display Character Data Write Setting Command

DAG 1 DA7	5		Register content	N			
DA0 to DA7	Register name	State	Function	Note			
7	_	1					
6	_	0	The command 1 identification code:	When this command is entered, the chip locks in display character write			
5	_	0	sets the display memory write address.	mode until the CS pin is set high.			
4	_	1					
3	_	0					
2	_	0					
1	0+0	at2	o+O	1 0+0	0	Turns character attribute 2 off.	Specifies highlight or flashing.
'	aız	1	Turns character attribute 2 on.	opecines riigriligrit or liasriling.			
0	at1	0	Turns character attribute 1 off.	Specifies reverse video.			
		1	Turns character attribute 1 on.	opecines reverse video.			

# Second byte

D40: D4=	5		Register content	
DA0 to DA7	Register name	State	Function	Note
7	с7	0		
/	C7	1		
6	c6	0		
	Сб	1		
_	5 c5	0		
5		1		
4	c4	0		
4		1	Character code (from 00 to FF (hexadecimal))	
3	c3	0		
	CO	1		
2	c2	0		
	02	1		
1	c1	0		
	CI	1		
0	c0	0		
	CU	1		

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

# 3 COMMAND2: Vertical Display Position Setting Command

# First byte

DAO to DAZ	Desister name			Register content	Note			
DA0 to DA7	Register name	Note	Note					
7	_	1						
6	_	0	The command 2 i	dentification code:				
5	_	1	sets the vertical d	isplay position.				
4	_	0						
3	3 SZ21	0	SZ20			7		
3	3221	1	SZ21	0	1	Character size for the second line	Character size for the second line	
0	0700	0	0	Normal size	Double size	Character size for the second line		
2	SZ20	1	1	Triple size	Normal size	_		
4	SZ11	0				7		
'	5211	1	SZ11	0	1	Character size for the first line		
0	0740		0	Normal size	Double size	Character size for the first line		
0	SZ10	1	1	Triple size	Normal size	_		

#### Second byte

DA0 to DA7	Desister name		Register content	Note
DAU IO DA7	Register name	Function	Note	
7	_	0	Second byte identification code	
6	_	0		
5	VP5	0	The vertical display start position is given by	
5	(MSB)	1	5	
4	VP4	0	$VS = H \times (\sum_{n=0}^{5} 2^{n}VPn)$	
4	VF4	1	where H is the horizontal synchronization pulse period.	
3	VP3	0	HSYNC	The six bits VP0 to VP5 specify the
3	VF3	1	\	vertical display start position.
2	VP2	0		The weight of the lsb is 1 × H.
2	VF2	1	l l îvs	
-	VP1	0	VSYNC	
'	VIFI	1	Character	
0	VP0	0	HS display area	
0	(LSB)	1		

Note: When the chip is reset by the  $\overline{RST}$  pin, the register states (bits) are all cleared to 0.

# 4 COMMAND3: Horizontal Display Position Setting Command

#### First byte

DA04- DA7	Danista a sana			Register content	Nete	
DA0 to DA7	Register name	State		Function		Note
7	_	1				
6	_	0	The command 3 i	dentification code:		
5	_	1		al display position.		
4	_	1				
3	SZB1	0	SZB0		1 .	7
3	SZBT	1	SZB1	0	1	
	0700	0	0	Normal size	Double size	The character size for the eleventh line.
2	SZB0	1	1	Triple size	Normal size	
_	SZ91	0	SZ90			1
'	5291	1	SZ91	0	1	
		0	0	Normal size	Double size	The character size for the ninth line.
0 SZ90	1	1	Triple size	Normal size		

# Second byte

DAG 1 DA7	Б		Register content	N .
DA0 to DA7	OA0 to DA7 Register name State		Function	Note
7	_	0	Second byte identification code	
6	_	0		
5	HP5	0		
5	(MSB)	1		
4	LID4	HP4 0		
4	11154	1	The horizontal display start position is given by	
3	HP3	0	$HS = Tc \times (\sum_{n=0}^{5} 2^{n}HPn)$	The six bits HP0 to HP5 specify the
3	HFS	1		vertical display start position.  The weight of the lsb is 1 x Tc.
2	HP2	0		The weight of the ISD IS TX TC.
2	TIFZ	1	where Tc is the period of the OSCIN and OSCOUT oscillator in operating mode.	
1	HP1	0	operating mode.	
'	i lifi	1		
0	HP0	0		
	(LSB)	1	the area interested as this base all all area day of	

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

# 5 COMMAND4: Display Control Setting Command 1

DAG 1 DA7	5		Register content	N .		
DA0 to DA7	Register name	State	Function	Note		
7	_	1				
6	_	1	The command 4 identification code:			
5	_	0	sets display control parameters.			
4	_	0				
		0				This reset occurs when the CS pin goes low, and the reset state cleared when
3	RST <sub>SYS</sub>	1	Resets all registers. (Clears all registers to 0.)	the $\overline{\text{CS}}$ pin goes high.		
	5444	0		The RAM erase function requires at least 500 µs.		
2	RAM <sub>ERS</sub>	1	Erases display RAM. (Sets display RAM to FF (hexadecimal).)	It is executed on DSPOFF.		
1	OSC <sub>STP</sub>	0	Continues crystal oscillator operation.	Only valid with character display off if		
	COSIP	1	Stops the crystal oscillator.	external synchronization is used.		
0	RND <sub>SEL</sub>	0	Turns off rounding.	Only valid for double and triple size		
U NINDSEL	, DSEL	1	Turns on rounding.	characters.		

# Second byte

DAG. DA7	B			Register content	N		
DA0 to DA7	Register name	State		Function		Note	
7	_	0	Second byte ide	entification code			
6	INT/NON	0	Interlaced			Switches between interlaced and	
6	INT/NON	1	Non-interlaced			non-interlaced display.	
5	BLK1	0	BLK0				
5	DLNI	1	BLK1	0	1	Changes the blanking size	
_	D11/0		0	0	Blanking off	Character size blanking	Changes the blanking size.
4	BLK0	1	1	Frame size blanking	Total area blanking		
	DICA	0	Flashing period	about 0.5 s		Code the flooring waste of	
3	BK1	1	Flashing period	about 1 s		Sets the flashing period.	
2	ATO	0	Highlight function	on		0-1	
2	ATS	1	Flashing function	n	Selects at2.		
1	_	0					
0			Character displa	ay off	Turns sharester output an and off		
0 DSPON 1			Character displa	ay on	Turns character output on and off.		

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

# 6 COMMAND5: Display Control Setting Command 2

DAG: DA7	<b>B</b>			Regist	er content													
DA0 to DA7	Register name	State			Function			Note										
7	_	1																
6	_	1	The comma	and 5 identific	cation code:													
5	_	0		control para														
4	_	1																
3	PH2	0	PHASE 2	PHASE 1	PHASE 0	Backgroi (phase)	und color											
			1				NTSC	PAL										
						0	0	0	π/2	±π/2								
		0	0	0	1	In phase	In phase	Sets the phase of the background color										
2	PH1		0	1	0	3 π/2	∓π/2	for color burst.sz										
						1	0	1	1	π	±π							
	1 PH0	PH0	PH0										1	0	0	3 π/4	±3 π/4	
						0	1	0	1	π/4	±π/4							
1				PH0		1	1	0	7 π/4	∓π/4								
		1	1	1	1	5 π/4	∓3 π/4											
0	INT/EXT	0	External synchronization mode					Switches between internal and external										
	INT/EXT	1	Internal syn	chronization	mode			synchronization.										

# Second byte

D40. D4=	5			Regist	er content														
DA0 to DA7	Register name	State			Function		Note												
7	_	0	Second byt	e identification	on code														
	TOT	0	Normal ope	ration			Test mode should not be used. This bit												
6	TST	1	Test mode				should always be zero.												
		0	Sets the ch	aracter inten	sity level to about 8	5 IRE (bright white).													
5	CHAL	1	Sets the ch touch of gre		sity level to about 72	Switches the character intensity level.													
		0	Sets the bla	•	ity level to about 3 I	Switches the blanking intensity level.													
4	BKL	1	Sets the bla as a frame	•	IRE (a dark grey														
		0	RSL1	RSL0	Intensity level	Amplitude													
3	RSL1	1	0	0	About 15 IRE	About 60 IRE													
			0	1	About 30 IRE	About 60 IRE	Switches the background intensity level												
2	DCI 0	DSLO	DSLO	DSI 0	BSI 0	RSI 0	RSI 0	RSL0	RSI 0	BSLO	PSLO	PSIO	2 RSI 0	0	1	0	About 45 IRE	About 60 IRE	g
2	HOLO	1	1	1	About 55 IRE	About 65 IRE													
	0)/	0	Normal CV	<sub>out</sub> output															
1	CV <sub>outmt</sub>	1	1 CV <sub>out</sub> pedestal level output																
0	VTAI	0	Selects XT/	AL1			Outline and a second												
0	XTALsel	1	Selects XT/	AL2			Switches the oscillator circuit												

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

# 7 COMMAND6: Display Control Setting Command 3

			Register content		
DA0 to DA7	Register name	State	Function	Note	
7	_	1			
6	_	1	The command 6 identification code:		
5	_	1	sets display control parameters.		
4	_	0			
0			Sets Fsc to 3.58 MHz.	The logical or of this bit and the Fsc	
3	MOD3	1	Sets Fsc to 4.43 MHz.	switching input pin (pin 14) is used.	
		0	Sets the color mode to NTSC.	The logical or of this bit and the color	
2	MOD2	1	Sets the color mode to PAL.	mode switching input pin (pin 13) is used.	
		0	Sets the number of scan lines to 525 lines.	The logical or of this bit and the scan	
1	1 MOD1	1	Sets the number of scan lines to 625 lines.	line count switching input pin (pin 12) is used.	
0	MODO	0	Sets the mode to a mode other than SECAM.	The logical or of this bit and the mode	
0	0 MOD0		Sets the mode to SECAM mode.	switching input pin (pin 11) is used.	

# Second byte

DAG 1 DA7	<b>D</b>			Regist	er content							
DA0 to DA7	Register name	State			Function	Note						
7	_	0	Second byt	e identification	on code							
6	HALF	0	Normal mo	de								
0	INT	1	Half interna	ıl synchronou	is mode							
_	P14OUT	0	Half tone o	utput		0-1						
5	SEL	1	High output	t in internal s	ynchronous mode	Selects P14 (3.58/4.43) output.						
4	SECAM	0	In SECAM	mode, only th	ne character frame area is on.	Colorte the CVCD "on" poried						
4	SEL	1	In SECAM	mode, the er	ntire character display area is on.	Selects the CVCR "on" period.						
3	IOS	0	Sets the mo	ode setting p	in to be an input pin.	Switches the input/output direction of						
3	105	1	Sets the mo	ode setting p	in to be an output pin.	the mode setting pins.						
		0	BCOL1	BCOL0	Background color							
2	BCOL1	1	0	0	Background color displayed	Determines whether a background color						
			0	1	No background color (about 13 IRE)	is displayed. (Only valid in internal						
1	BCOLO.	BCOL0	BCOL0	BCOL0	BCOL0	BCOL0	BCOL0	0	1	0	No background color (about 23 IRE)	synchronization mode.)
	20020	1	1	1	CV <sub>outmt2</sub> (CSYNC)							
0	CROFE	0	Outputs a c	olor burst sig	gnal.	Only valid when either BCOL0 is 1 or						
0	0 CBOFF		Stops the o	utput of colo	r burst signals.	BCOL1 is 1.						

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

# 8 COMMAND70: Display Control Setting Command 4

# First byte

DAG 1 DA7	DAGA- DAZ   Danistan sana		Register content	
DA0 to DA7	Register name	State	Function	Note
7	_	1		
6	_	1	The command 7 identification code:	
5	_	1	sets display control parameters.	
4	_	1		
3	_	0		
2	_	0	Expansion command 0 identification code	
1	_	0		
0	LINS	0	Selects the lower 6 bits (bits 0 to 5)	Selects the upper or lower six bits when
0	LINS	1	Selects the upper 6 bits (bits 6 to B)	halftone output line mode is specified.

# Second byte

D401 D47	D		Register content		
DA0 to DA7	DA0 to DA7 Register name		Function	Note	
7	_	0	Second byte identification code		
	VCO	0	VCO frequency is 14.12 MHz	Colorto VCC appillation fraguency	
6	SELECT1	1	VCO frequency is 7.07 MHz	Selects VCO oscillation frequency.	
	LINE	0	Turns off (low) sixth line halftone output.	Used for the line 12 setting when LINS	
5	LIN5	1	Turns on (high) sixth line halftone output.	is high.	
4	1.1014	1.1514	0	Turns off (low) fifth line halftone output.	Used for the line 11 setting when LINS
4	LIN4	1	Turns on (high) fifth line halftone output.	is high.	
3	LING	0	Turns off (low) fourth line halftone output.	Used for the line 10 setting when LINS	
3	LIN3	1	Turns on (high) fourth line halftone output.	is high.	
2	LIN2	0	Turns off (low) third line halftone output.	Used for the line 9 setting when LINS is	
2	LINZ	1	Turns on (high) third line halftone output.	high.	
-1	LINIA	0	Turns off (low) second line halftone output.	Used for the line 8 setting when LINS is	
1 LIN1		1	Turns on (high) second line halftone output.	high.	
0	LIN0	0	Turns off (low) first line halftone output.	Used for the line 7 setting when LINS is	
U	LINU	1	Turns on (high) first line halftone output.	high.	

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

# 9 COMMAND71: Display Control Setting Command 5

# First byte

DA0 to DA7	DA0 to DA7 Register name		Register content	Note
DAU IO DA7	Register name	State	Function	Note
7	_	1		
6	_	1	The command 7 identification code: sets display	
5	_	1	control parameters	
4	_	1		
3	_	0	Expansion command 1 identification code	
2	_	1	Expansion command 1 identification code	
1	_	0		
0	LINS	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half tone output line setting.
0	LING	1	Selects upper 6 bits (6 to B).	

# Second byte

DAG 4- DAZ	DA0 to DA7 Register name		Register content	Note
DAU to DA7			Function	Note
7	_	0	Second byte identification bit	
6	EGMODE	0	Normal display	
	2SELECT	1	Apply frame to inverted characters also.	
5	PORTSET	0	Set port output data	
5	SELECT2	1	Set port (output switching)	
4	PORTSET	0	Set port output data	
4	SELECT1	1	Set port (output switching)	
3	VMN	0	Normal V signal	
3	SEL	1	VMASK signal	
2	VINPsel	0	Normal I/O	
2	VIIVESEI	1	V is input from P11.	
4	VNPsel	0	V rise detection	Selects V detection polarity.
'	VINESEI	1	V fall detection	Toblects v detection polarity.
0	VSEPsel	0	VSEP is about 9.3 µs.	Selects V separation time.
0	VOLFSEI	1	VSEP is about 18.6 μs.	Gelecia v Separation time.

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

# 10 COMMAND72: Display Control Setting Command 6

DA0+- DA7	Donistan same	Register content		Note	
DA0 to DA7	Register name	State	Function	Note	
7	_	1			
6	_	1	The command 7 identification code: sets display		
5	_	1	control parameters		
4	_	1			
3	_	1	Expansion command 2 identification code		
2	_	0	Expansion command 2 identification code		
1	_	0			
0	LINS	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half	
	LING	1	Selects upper 6 bits (6 to B).	tone output line setting.	

# Second byte

DAG   DA7	A7 Register name	Register content			
DA0 to DA7		State	Function	Note	
7	_	0	Second byte identification bit		
6	_	0			
5	_	0			
4	4 — 0				
3	MOD3 SEL	0	Normal MOD3 (P14) output (PS1 = 1)	Specifies port output data	
3		1	Specifies MOD3 general port output	when PS1 = 0.	
2	MOD2	0	Normal MOD2 (P13) output (PS1 = 1)	Specifies port output data	
2	SEL 1 S	Specifies MOD2 general port output	when PS1 = 0.		
1	MOD1	0	Normal MOD1 (P12) output (PS1 =1)	Specifies port output data	
'	SEL	1	Specifies MOD1 general port output	when PS1 = 0.	
0	MOD0	0	Normal MOD0 (P11) output (PS1 = 1)	Specifies port output data	
0	SEL	1	Specifies MOD0 general port output	when PS1 = 0.	

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

# 11 COMMAND73: Display Control Setting Command 7

# First byte

	Register name	Register content			
DA0 to DA7		to DA7 Register name		Function	Note
7	_	1			
6	_	1	The command 7 identification code: sets display		
5	_	1	control parameters		
4	_	1			
3	_	1	Expansion command 3 identification code		
2	_	1	Expansion command 3 identification code		
1	_	0			
0	LINS	LINC	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half
0		1	Selects upper 6 bits (6 to B).	tone output line setting.	

# Second byte

DAG 1 DA7	5	Register content			
DA0 to DA7	Register name	State	Function	Note	
7	_	0	Second byte identification bit		
6	_	0			
5	_	0			
4	_	0			
3	VCP SELECT2	VCP	0 No feedback	No feedback resistance	Specifies VCO oscillator feedback
3		1	Feedback resistance	resistance connection	
2		SDETOUT	0	Normal SOUT (P29) output (PS2 = 1)	Specifies port output data
2		Specifies SOUT general port output	when PS2 = 0.		
4	VOUT	0	Normal VOUT (P7) output (PS2 =1)	Specifies port output data	
'	SEL	1	Specifies VOUT general port output	when PS2 = 0.	
0	0 HOUT SEL	0	Normal HOUT (P4) output (PS2 = 1)	Specifies port output data	
U		1	Specifies HOUT general port output	when PS2 = 0.	

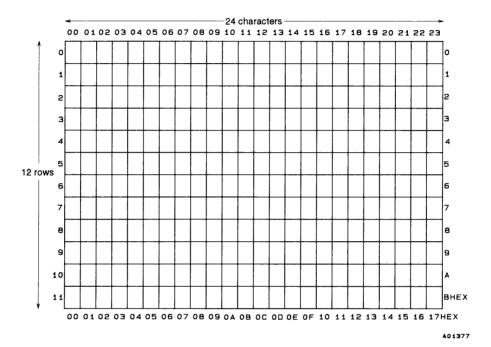
Note: When the chip is reset by the  $\overline{\mbox{RST}}$  pin, the register states (bits) are all cleared to 0.

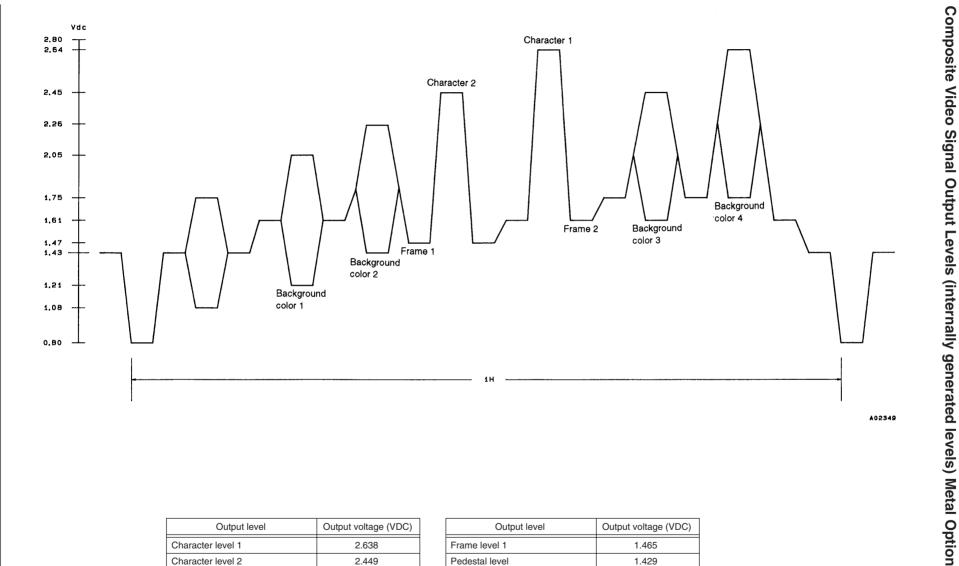
# **Display Configuration**

The display consists of 12 rows of 24 characters each. Up to 288 characters can be displayed unless enlarged characters are displayed. Display memory addresses are expressed as a row address in the range 0 to B (hexadecimal) and a column address in the range 0 to 17 (hexadecimal).

# **Display Configuration and Display Memory Addresses**

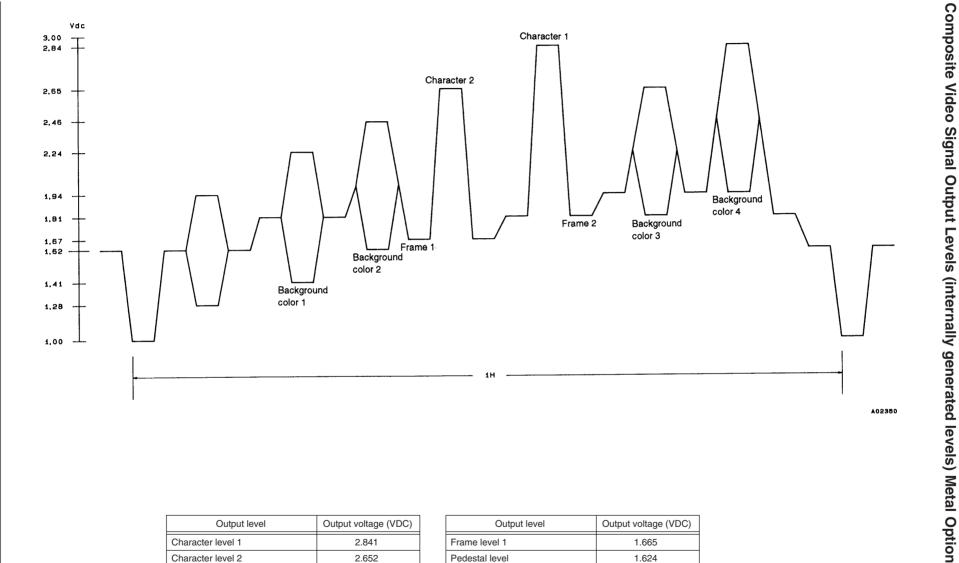
24 characters by 12 rows





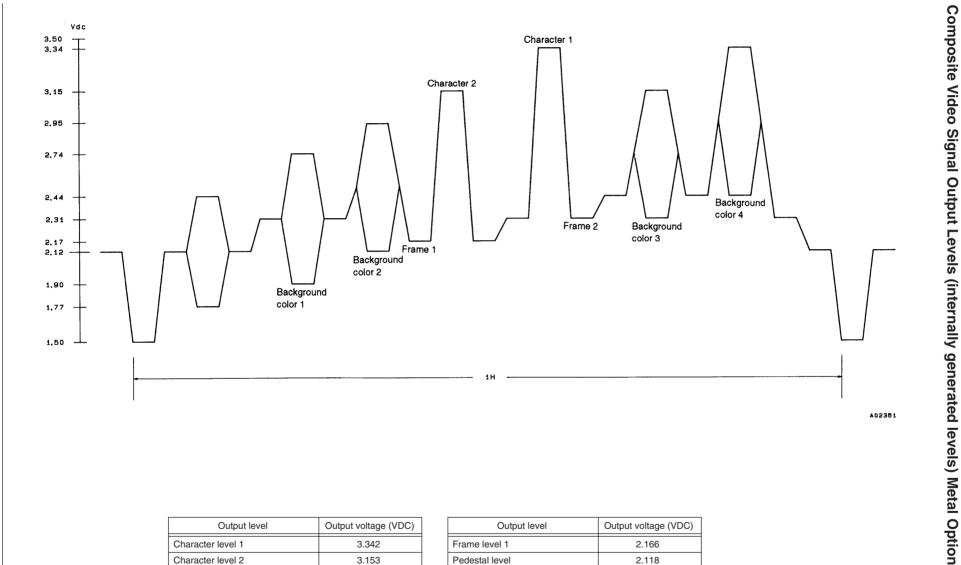
Output level	Output voltage (VDC)
Character level 1	2.638
Character level 2	2.449
Background high level 2	2.262
Background high level 1	2.047
Burst high level	1.747
Frame level 2	1.610

Output level	Output voltage (VDC)		
Frame level 1	1.465		
Pedestal level	1.429		
Background low level 1	1.212		
Burst low level	1.080		
Sync level	0.800		



Output level	Output voltage (VDC)
Character level 1	2.841
Character level 2	2.652
Background high level 2	2.456
Background high level 1	2.242
Burst high level	1.943
Frame level 2	1.811

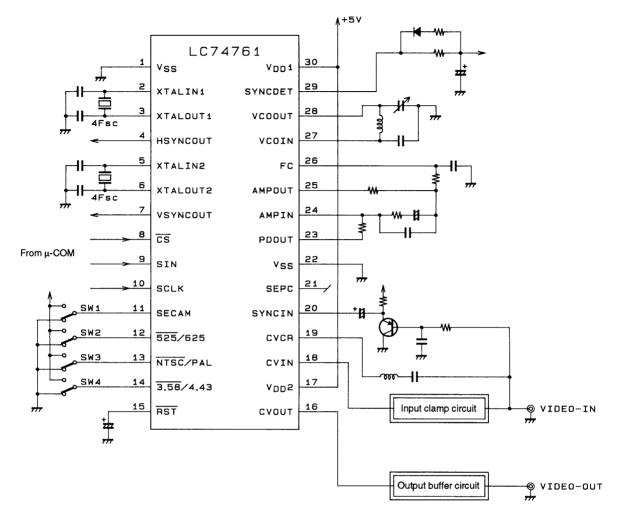
Output level	Output voltage (VDC)
Frame level 1	1.665
Pedestal level	1.624
Background low level 1	1.407
Burst low level	1.275
Sync level	1.000



Output level	Output voltage (VDC)
Character level 1	3.342
Character level 2	3.153
Background high level 2	2.950
Background high level 1	2.735
Burst high level	2.436
Frame level 2	2.312

Output level	Output voltage (VDC)
Frame level 1	2.166
Pedestal level	2.118
Background low level 1	1.902
Burst low level	1.770
Sync level	1.500

# **Application Circuit Diagram**



A02566

Signal format	4 Fsc (MHz)
NTSC	3.579545 × 4
PAL	4.433618 × 4
SECAM	4.433618 × 4
PAL-M	3.575611 × 4
PAL-N	3.582056 × 4
NTSC4.43	4.433618 × 4
PAL60	4 433618 × 4

Signal format	SW1	SW2	SW3	SW4
NTSC	0	0	0	0
PAL	0	1	1	1
SECAM	1	(1)	(1)	(1)
PAL-M	0	0	1	0
PAL-N	0	1	1	0
NTSC4.43	0	0	0	1
PAL60	0	0	1	1

PAL60 4.433618 × 4 FALOU

Note: Fix SW1 to SW4 to 0 when setting a mode by command.

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